Specification of Thermoelectric Module

TES1-06339

Description

The 63 couples, 30 mm × 15 mm size single module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 70 ºC, designed for superior cooling and heating up to 100 ºC applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

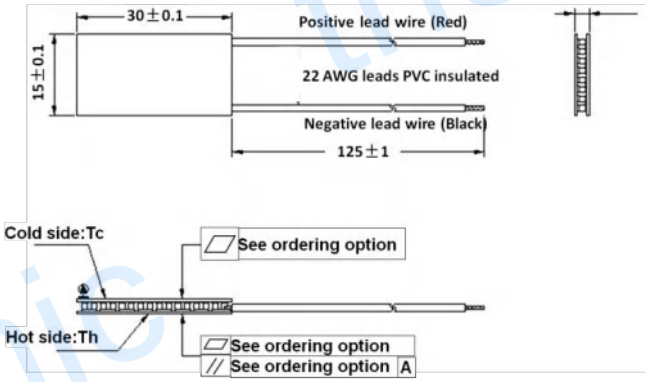
Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

Th(ºC)	27	50	Hot side temperature at environment: dry air, N_2
DT_{max}(ºC)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U_{max}(Voltage)	8.0	8.7	Voltage applied to the module at DT_{max}
I_{max}(Amps)	4.3	4.3	DC current through the modules at DT_{max}
Q_{Cmax}(Watts)	21.2	22.9	Cooling capacity at cold side of the module under DT=0 ºC
AC resistance(Ohms)	1.4	1.5	The module resistance is tested under AC
Tolerance (%)	± 10		For thermal and electricity parameters

Geometric Characteristics Dimensions in millimeters



Manufacturing Options

A. Solder:

1. T100: BiSn (Tmelt=138ºC)
2. T200: CuAgSn (Tmelt = 217°C)
3. T240: SbSn (Tmelt = 240°C)

B. Sealant:

1. NS: No sealing (Standard)
2. SS: Silicone sealant
3. EPS: Epoxy sealant

C. Ceramics:

1. Alumina (Al_2O_3, white 96%)
2. Aluminum Nitride (AlN)

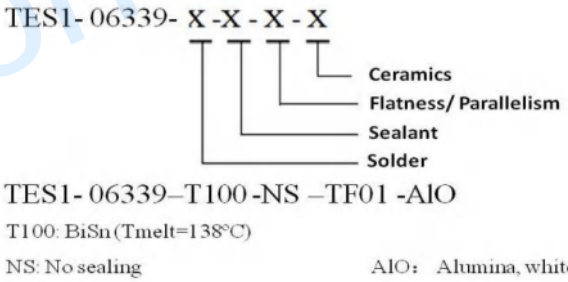
D. Ceramics Surface Options:

1. Blank ceramics (not metalized)
2. Metalized

Ordering Option

Suffix	Thickness H(mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length
TF	0:3.2± 0.1	0: 0.07/0.07	125 ± 1/Specify
TF	1:3.2± 0.03	1: 0.025/0.025	125 ± 1/Specify
Eg. TF01: Thickness3.2 ± 0.1(mm) and Flatness 0.025/0.025 (mm)			

Naming for the Module



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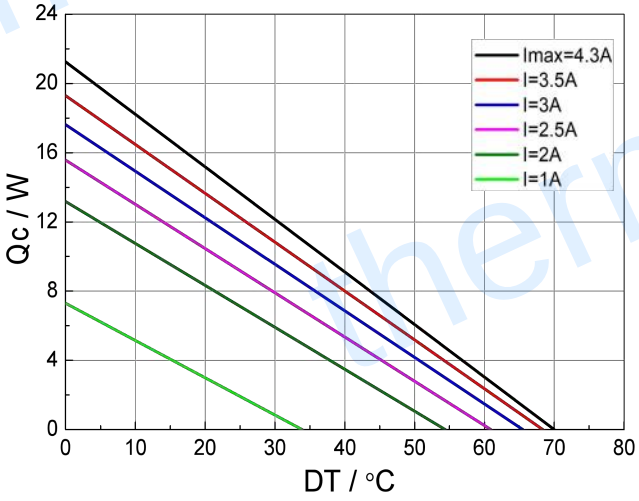
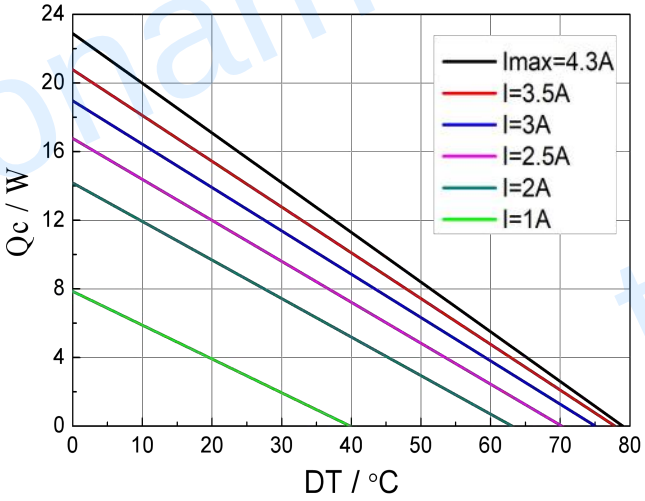
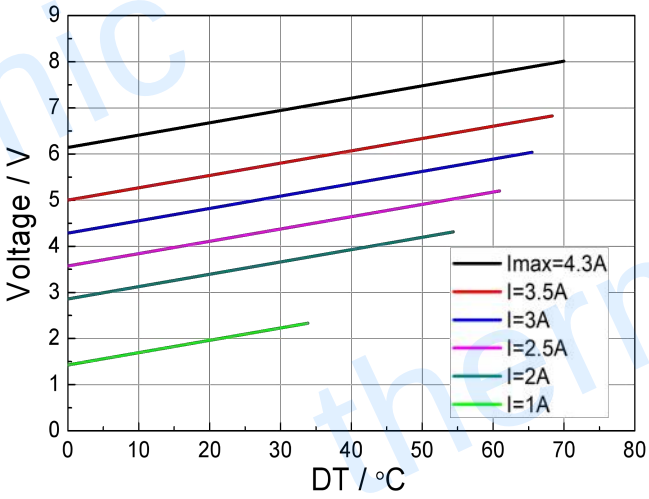
Performance Curves at Th=27 ºC

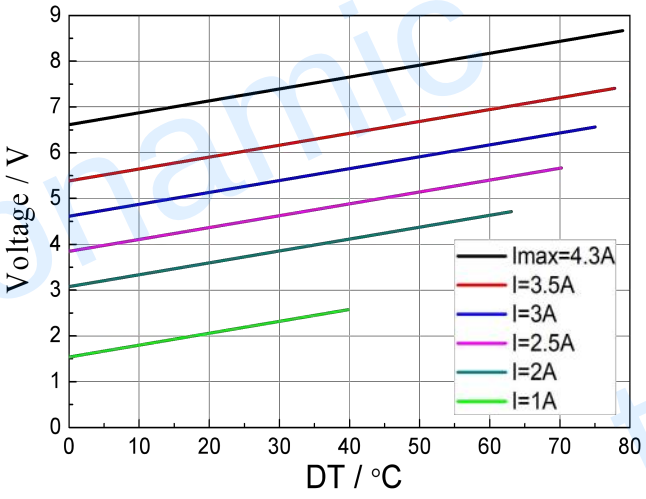


Performance Curves at Th=50 ºC

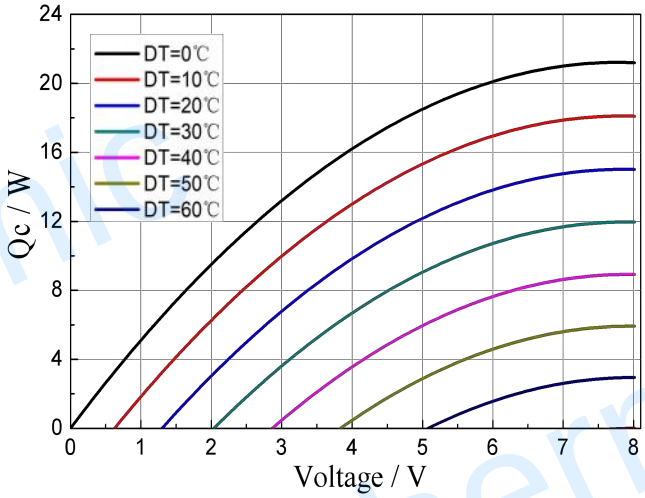


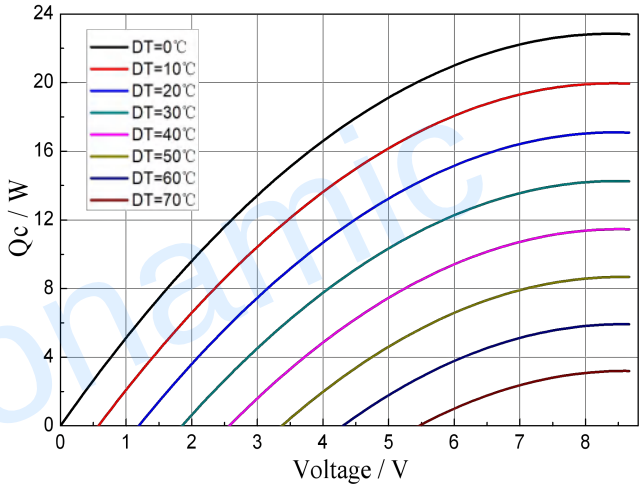
Standard Performance Graph Qc= f(DT)





Standard Performance Graph V= f(DT)





Standard Performance Graph Qc= f(V)

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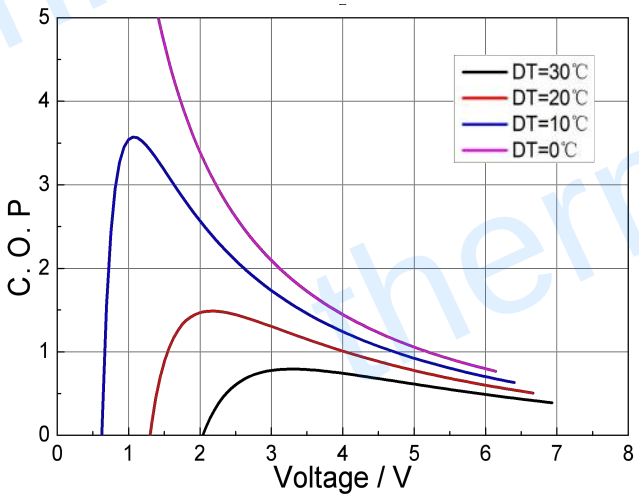
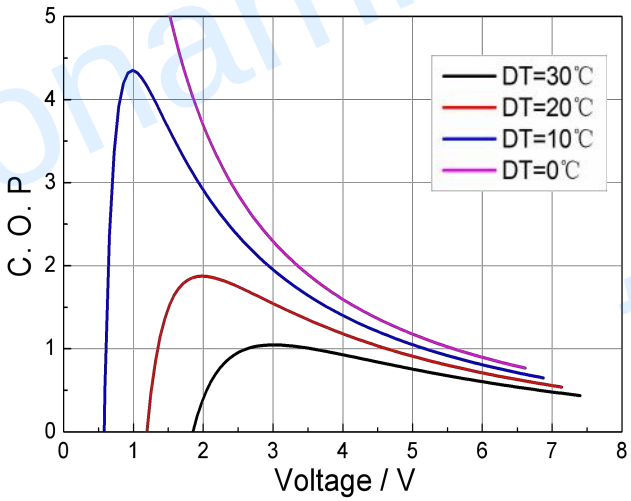
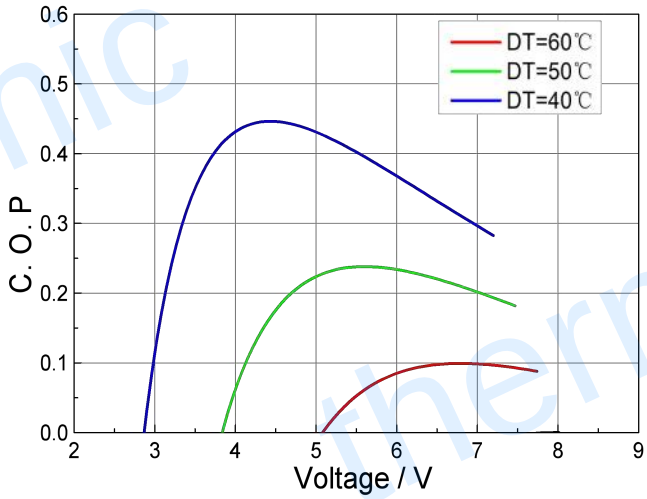
Performance Curves at Th=27 ºC

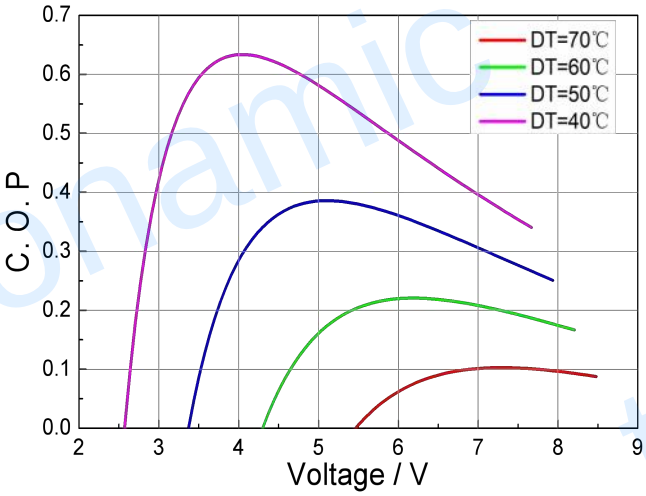


Performance Curves at Th=50 ºC



Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 ˚C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 ˚C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V × I).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation or storage module below 100 ºC
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.